Pb-FREE PRODUCTS 無鉛產品

	Item	Test Method & Conditions	Specification After Test				
No	[項目]	[試驗方法、條件]	[試驗後規格]				
A. Mechanical Characteristics 機械特性							
1	Operating Temperature 工作溫度	Temp. Range: Ceramic Material: $-40 ^{\circ}\text{C} \sim +125 ^{\circ}\text{C}$ Ferrite Material: $-40 ^{\circ}\text{C} \sim +85 ^{\circ}\text{C}$					
2	Storage temperature and Humidity range 儲存溫度濕度	- 10 ~ +40°C ; 20 to 70% RH.					
3	Solder Heat Resistance 抗焊錫熱特性	 Dip the components into flux and dip into solder pot containing lead free solder at 260 °C ± 5 °C for 5 ± 2 seconds. Temperature profile 	 Change In Inductance: No more than 5% Change In Q: No more than 10% Change In Appearance: Without distinct damage 				
* (Temperature of the mounte		250 Peak temp 250°C 10Sec 220 1~4°C/sec	 Reflow: 250°C Max 250°C up/within 10secs Gradient of temperature rise: av 1-4°C/sec 				
		Preheat 90~120Sec **DEVICE BODY TEMP Dip temperature	Preheat: 160-190°C/within 90-121secs 220°C up/within 30-61secs Solder: Sn-3Ag-0.5Cu				
		Tempreture(°C) 260 250 Peak temp 260°C 3~5Sec 255±5°C Preheat 100	 Solder temperature: 260°C max whithin 5secs. Preheating temperature: 100~130°C, deposit solder temperature. Solder: Sn-3Ag-0.5Cu 				
		☐ Soldering iron tip temperature : Iron Tip temp. 350°C Less than 3Sec Soldering I					

JANTIK HIGH FREQUENCY WOUND CHIP INDUCTOR SERIES

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$\frac{\mathbf{A}}{4}$	IVIECHAMIC Solderability 焊錫性	· Dip pads in flux and dip in solder pot containing lead free solder at 240 °C ± 5°C for 5 seconds.	A minimum of 80% of the metalized are a must be covered with solder.			
5	Component Adhesion (Push Test) 推力試験	 The component shall be reflow soldered onto a P. C. Board (240 °C ± 5°C for 20 seconds). Then a dynometer force gauge shall be applied to any side of the component. 	· 0402 series - 350g 0603 series - 1.0Kg Other series - 0805 ~ 1812 Minimum 1Kg for Pd/Ag termination and 2Kg for Mo/Mn termination.			
6	Vibration (Random) 振動試験	 Inductors shall be randomly vibrated at amplitude of 1.5mm and frequency of 10 - 55 Hz: 0.04 G / Hz for a minimum of 15 minutes per axis for each of the three axes. Change In Inductance: No more than 10% Change In Appearance: Without distinct damage 				
7	Drop Test 落下試驗	The inductor shall be dropped two times on the concrete floor or the vinyl tile from 1M naturally.	 Change In Inductance: No more than 5% Change In Q: No more than 10% Change In Appearance: Without distinct damage 			
B . Environmental Characteristics 環境試驗						
8	Cold Temperature Storage 低溫儲存	 Inductors shall be stored at temperature of -40 °C ± 2 °C for 1000hrs (+ 48 -0 hrs.) Then inductors shall be subjected to standard atmospheric conditions for 1 hour. After that, measurement shall be made. 	 Change In Inductance: No more than 5% Change In Q: No more than 10% Change In Appearance: 			
9	High Temperature Storage 高溫儲存	 Inductors shall be stored at temperature of 85 °C ± 2 °C for 1000hrs (+48 - 0hrs.) Then inductors shall be subjected to standard atmospheric conditions for 1 hour. After that, measurement shall be made. 	 Change In Inductance: No more than 5% Change In Q: No more than 10% Change In Appearance: Without distinct damage 			
10	Moisture Resistance 耐溼試驗	 Inductors shall be stored in the chamber at 45 °C at 90 - 95 R. H. for 1000 hours. Then inductors are to be tested after 2 hours at room temperature. 	Inductors shall not have a shorted or open winding.			

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B. Environmental Characteristics 環境試驗								
11 High Tempera with Loa 高溫負載	at +85 °C for 1000 current applied. In at the beginning of and 1000 hours.	ductors shall be tested f test at 500 hours to be tested after 1 hour						
12 Thermal Test 熱衝擊記	minutes at -40 °C for	 Change In Q: No more than 10% With a 20-second Change In Appearance: Without distinct damage 						